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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

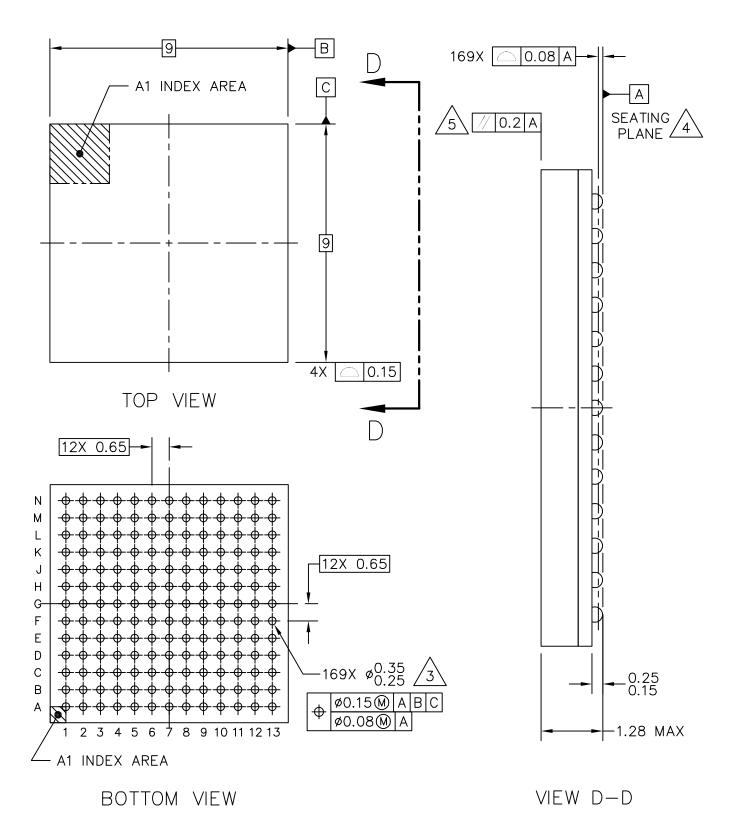
Applications of "<u>Embedded - Microcontrollers</u>"

Details		
Product Status	Active	
Core Processor	ARM® Cortex®-M4	
Core Size	32-Bit Single-Core	
Speed	180MHz	
Connectivity	CANbus, EBI/EMI, Ethernet, I ² C, IrDA, SD, SPI, UART/USART, USB, USB OTG	
Peripherals	DMA, I ² S, LVD, POR, PWM, WDT	
Number of I/O	116	
Program Memory Size	1MB (1M x 8)	
Program Memory Type	FLASH	
EEPROM Size	4K x 8	
RAM Size	256K x 8	
Voltage - Supply (Vcc/Vdd)	1.71V ~ 3.6V	
Data Converters	A/D 2x16b; D/A 2x12b	
Oscillator Type	Internal	
Operating Temperature	-40°C ~ 105°C (TA)	
Mounting Type	Surface Mount	
Package / Case	169-LFBGA	
Supplier Device Package	169-MAPBGA (9x9)	
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/mk65fx1m0vmi18	

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9 X 9 X 1.15 PKG 0.65 MM PITCH, 169 I/O		STANDARD: NON-JEDEC		
		29 AUG 2013		



NOTES:

- 1. ALL DIMENSIONS IN MILLIMETERS.
- 2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.



MAXIMUM SOLDER BALL DIAMETER MEASURED PARALLEL TO DATUM A.



DATUM A, THE SEATING PLANE, IS DETERMINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



PARALLELISM MEASUREMENT SHALL EXCLUDE ANY EFFECT OF MARK ON TOP SURFACE OF PACKAGE.

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